Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

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TDK

February 2017

Inductors for Standard Circuits

Multilayer Ferrite

MLF Series

MLF2012 Type

MLF2012	**2012 [0805 inch]***

*** Dimensions Code JIS[EIA]**

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

⚠ REMINDERS

- The storage period is less than 12 months. Be sure to follow the storage conditions (Temperature: 5 to 40°C, Humidity: 10 to 75% RH or less).
  If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
- Before soldering, be sure to preheat components.
  The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications.
  If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Carefully lay out the coil for the circuit board design of the non-magnetic shield type.
  A malfunction may occur due to magnetic interference.
- Use a wrist band to discharge static electricity in your body through the grounding wire.
- Do not expose the products to magnets or magnetic fields.
- Do not use for a purpose outside of the contents regulated in the delivery specifications.
- The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.
  The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property.
  If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in the each catalog, please contact us.

(1) Aerospace/Aviation equipment
(2) Transportation equipment (cars, electric trains, ships, etc.)
(3) Medical equipment
(4) Power-generation control equipment
(5) Atomic energy-related equipment
(6) Seabed equipment
(7) Transportation control equipment
(8) Public information-processing equipment
(9) Military equipment
(10) Electric heating apparatus, burning equipment
(11) Disaster prevention/crime prevention equipment
(12) Safety equipment
(13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.

Inductors for Standard Circuits

Multilayer Ferrite

Product compatible with RoHS directive
Halogen-free
Compatible with lead-free solders

Overview of MLF2012 Type

FEATURES

- The lineup includes a wide inductance range.
- Highly reliable monolithic structure with multilayer integration.

APPLICATION

Smart phones, tablet terminals, tuners, LCD-TVs, PDP-TVs, audio equipment, computers, signal processing for modules etc.

PART NUMBER CONSTRUCTION

MLF	2012	D	47N	△	T	000

Series name

L×W×H Dimensions (mm)

2012	2.0×1.25×0.85
	2.0×1.25×1.25

characteristics

A
C
D
E
K

Inductance (μH)

10N	0.010 (10nH)
R10	0.1
1R0	1
100	10

Inductance tolerance

J	±5%
K	±10%
M	±20%

Packaging style

T	Taping

Internal code

000

OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

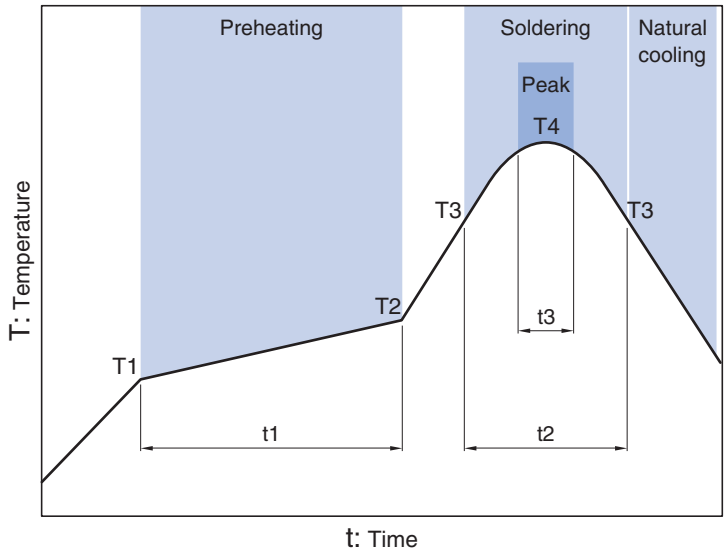
Type		Temperature range* Operating temperature (°C)	Temperature range* Storage temperature** (°C)	Package quantity (pieces/reel)	Individual weight (mg)
MLF2012	t=0.85	–55 to +125	–55 to +125	4,000	10
	t=1.25			2,000	14

* In case the product's inductance is 15μH or higher, both Operating and Storage temperature ranges are –40 to +85°C.
** The Storage temperature range is for after the circuit board is mounted.

- RoHS Directive Compliant Product: See the following for more details.https://product.tdk.com/info/en/environment/rohs/index.html
- Halogen-free: Indicates that Cl content is less than 900ppm, Br content is less than 900ppm, and that the total Cl and Br content is less than 1500ppm.

MLF2012 Type

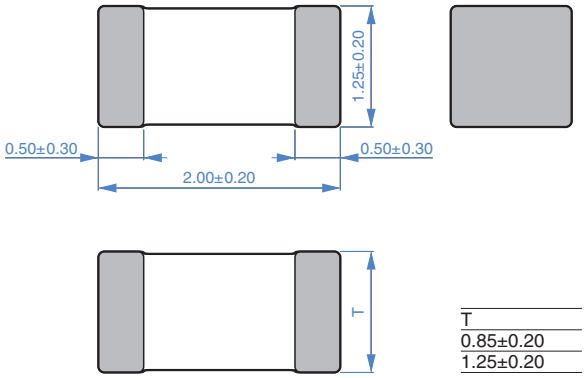
RECOMMENDED REFLOW PROFILE



Preheating			Soldering		Peak	
Temp.		Time	Temp.	Time	Temp.	Time
T1	T2	t1	T3	t2	T4	t3
150°C	180°C	60 to 120s	230°C	30 to 60s	250 to 260°C	10s max.

MLF2012 Type

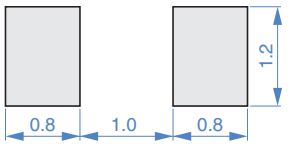
SHAPE & DIMENSIONS



T
0.85±0.20
1.25±0.20

Dimensions in mm

RECOMMENDED LAND PATTERN



Dimensions in mm

MLF2012 Type

■ELECTRICAL CHARACTERISTICS

□CHARACTERISTICS SPECIFICATION TABLE

L		Q		L, Q measuring conditions		Self-resonant frequency		DC resistance		Rated current	Thickness	Part No.*
				Frequency	Current						T	
(μH)	Tolerance	min.	typ.	(MHz)	(mA)	(MHz) min.	(MHz) typ.	(Ω) max.	(Ω) typ.	(mA) max.	(mm)	
0.047	±20%	15	25	50	1.0	550	700	0.10	0.05	300	0.85	MLF2012D47N △ T000
0.068	±20%	15	25	50	1.0	500	600	0.15	0.08	300	0.85	MLF2012D68N △ T000
0.082	±20%	15	25	50	1.0	450	550	0.15	0.08	300	0.85	MLF2012D82N △ T000
0.10	±5%±10%±20%	20	30	25	1.0	400	500	0.15	0.10	300	0.85	MLF2012DR10 △ T000
0.12	±5%±10%±20%	20	30	25	1.0	360	450	0.20	0.12	300	0.85	MLF2012DR12 △ T000
0.15	±5%±10%±20%	20	30	25	1.0	320	410	0.20	0.13	300	0.85	MLF2012DR15 △ T000
0.18	±5%±10%±20%	20	30	25	1.0	280	370	0.25	0.15	300	0.85	MLF2012DR18 △ T000
0.22	±5%±10%±20%	20	30	25	1.0	250	330	0.30	0.16	250	0.85	MLF2012DR22 △ T000
0.27	±5%±10%±20%	20	30	25	1.0	220	300	0.35	0.18	250	0.85	MLF2012DR27 △ T000
0.33	±5%±10%±20%	20	30	25	1.0	200	270	0.40	0.23	250	0.85	MLF2012DR33 △ T000
0.39	±5%±10%±20%	25	35	25	1.0	180	250	0.45	0.25	200	0.85	MLF2012DR39 △ T000
0.47	±5%±10%±20%	25	35	25	1.0	160	230	0.50	0.25	200	1.25	MLF2012DR47 △ T000
0.56	±5%±10%±20%	25	35	25	1.0	150	210	0.55	0.30	150	1.25	MLF2012DR56 △ T000
0.68	±5%±10%±20%	25	35	25	1.0	140	190	0.60	0.35	150	1.25	MLF2012DR68 △ T000
0.82	±5%±10%±20%	25	35	25	1.0	130	170	0.65	0.40	150	1.25	MLF2012DR82 △ T000
1.0	±5%±10%±20%	45	55	10	1.0	120	160	0.30	0.15	80	0.85	MLF2012A1R0 △ T000
1.2	±5%±10%±20%	45	55	10	1.0	110	150	0.35	0.15	80	0.85	MLF2012A1R2 △ T000
1.5	±5%±10%±20%	45	60	10	1.0	100	140	0.40	0.18	80	0.85	MLF2012A1R5 △ T000
1.8	±5%±10%±20%	45	60	10	1.0	90	130	0.45	0.20	80	0.85	MLF2012A1R8 △ T000
2.2	±5%±10%±20%	45	60	10	1.0	80	120	0.50	0.22	50	0.85	MLF2012A2R2 △ T000
2.7	±5%±10%±20%	45	70	10	1.0	70	100	0.55	0.25	50	1.25	MLF2012A2R7 △ T000
3.3	±5%±10%±20%	45	70	10	1.0	60	90	0.60	0.28	50	1.25	MLF2012A3R3 △ T000
3.9	±5%±10%±20%	45	70	10	1.0	55	80	0.65	0.30	30	1.25	MLF2012A3R9 △ T000
4.7	±5%±10%±20%	45	70	10	1.0	50	70	0.70	0.35	30	1.25	MLF2012A4R7 △ T000
5.6	±5%±10%±20%	50	75	4	0.1	45	65	0.60	0.30	15	1.25	MLF2012E5R6 △ T000
6.8	±5%±10%±20%	50	75	4	0.1	40	60	0.65	0.32	15	1.25	MLF2012E6R8 △ T000
8.2	±5%±10%±20%	50	75	4	0.1	35	55	0.70	0.35	15	1.25	MLF2012E8R2 △ T000
10	±5%±10%±20%	50	75	2	0.1	30	50	0.80	0.40	15	1.25	MLF2012E100 △ T000
12	±5%±10%±20%	50	75	2	0.1	25	45	0.90	0.50	15	1.25	MLF2012E120 △ T000
15	±10%±20%	30	45	1	0.1	22	40	0.70	0.35	5	1.25	MLF2012C150 △ T000
18	±10%±20%	30	45	1	0.1	20	38	0.80	0.38	5	1.25	MLF2012C180 △ T000
22	±10%±20%	30	45	1	0.1	18	35	0.90	0.45	5	1.25	MLF2012C220 △ T000
27	±10%±20%	30	45	1	0.1	17	33	1.00	0.50	5	1.25	MLF2012C270 △ T000
33	±10%±20%	30	45	0.4	0.1	15	28	1.10	0.55	5	1.25	MLF2012C330 △ T000
39	±10%±20%	35	55	2	0.1	13	23	2.40	1.30	4	1.25	MLF2012K390 △ T000
47	±10%±20%	35	55	2	0.1	11	20	2.70	1.60	4	1.25	MLF2012K470 △ T000
56	±10%±20%	35	55	2	0.1	10	18	2.80	1.80	4	1.25	MLF2012K560 △ T000
68	±10%±20%	25	45	1	0.1	9	16	2.90	2.00	2	1.25	MLF2012C680 △ T000
82	±10%±20%	25	45	1	0.1	8	14	3.00	2.40	2	1.25	MLF2012C820 △ T000
100	±10%±20%	25	45	1	0.1	7	12	3.10	2.50	2	1.25	MLF2012C101 △ T000

* The " △ " of the Part Number contains the inductance tolerance code, J (±5%), K (±10%), or M (±20%).

○ Measurement equipment

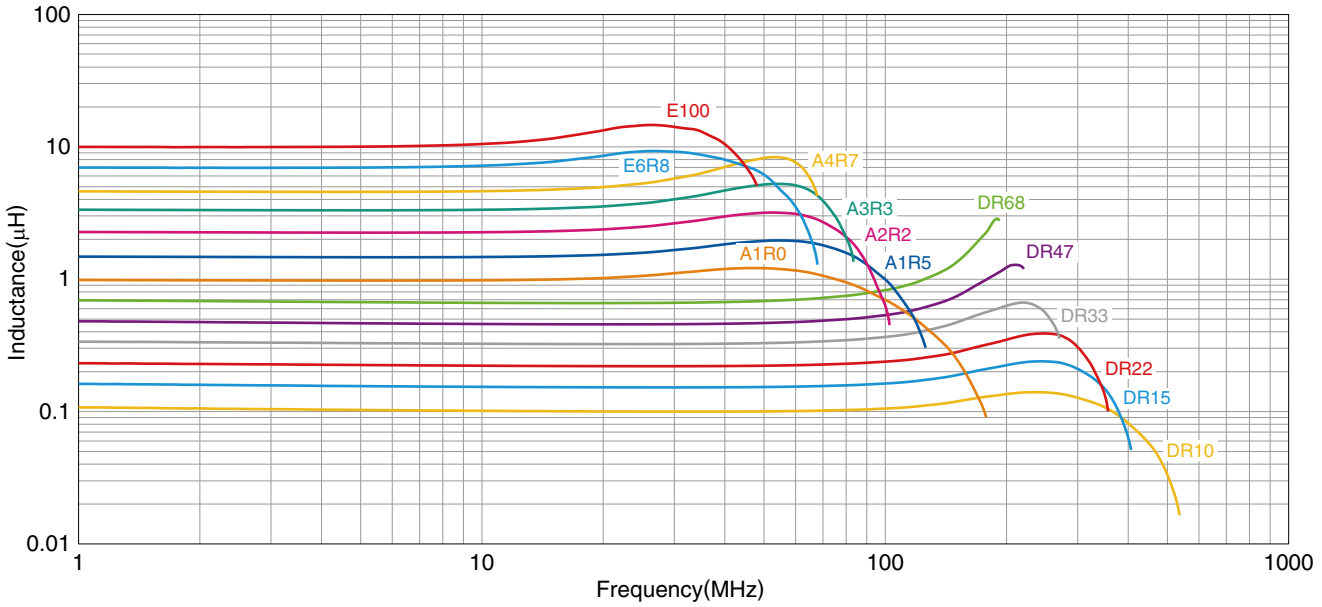
Measurement item	Product No.	Manufacturer
L, Q	4294A+16034G	Keysight Technologies
Self-resonant frequency	E4991A	Keysight Technologies
DC resistance	Type-7561	Yokogawa

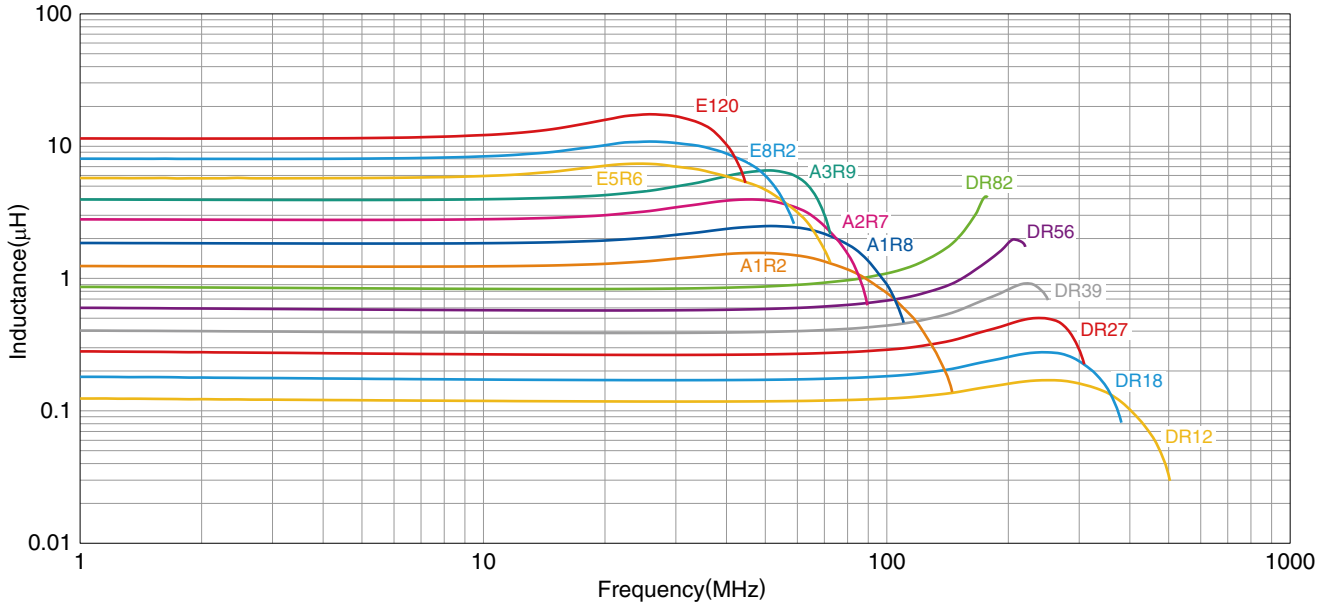
∗ Equivalent measurement equipment may be used.

MLF2012 Type

■ELECTRICAL CHARACTERISTICS

□L FREQUENCY CHARACTERISTICS GRAPH





○ Measurement equipment

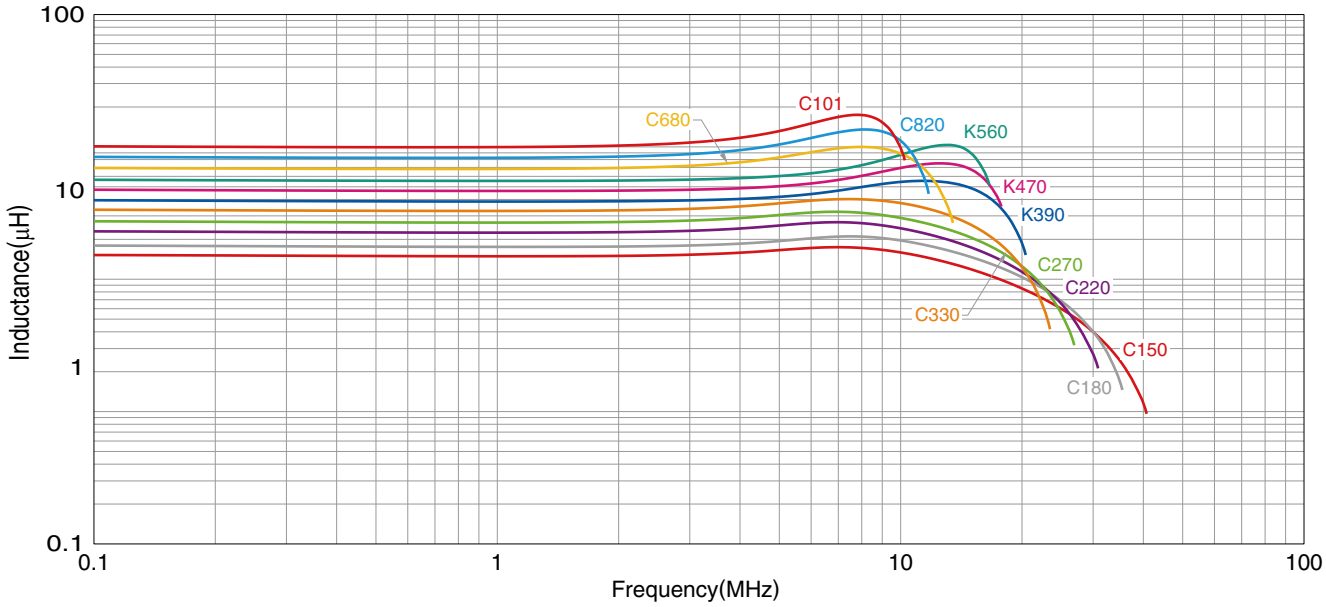
Product No.	Manufacturer
E4991A+16192A	Keysight Technologies

＊ Equivalent measurement equipment may be used.

MLF2012 Type

■ELECTRICAL CHARACTERISTICS

□L FREQUENCY CHARACTERISTICS GRAPH



○ Measurement equipment

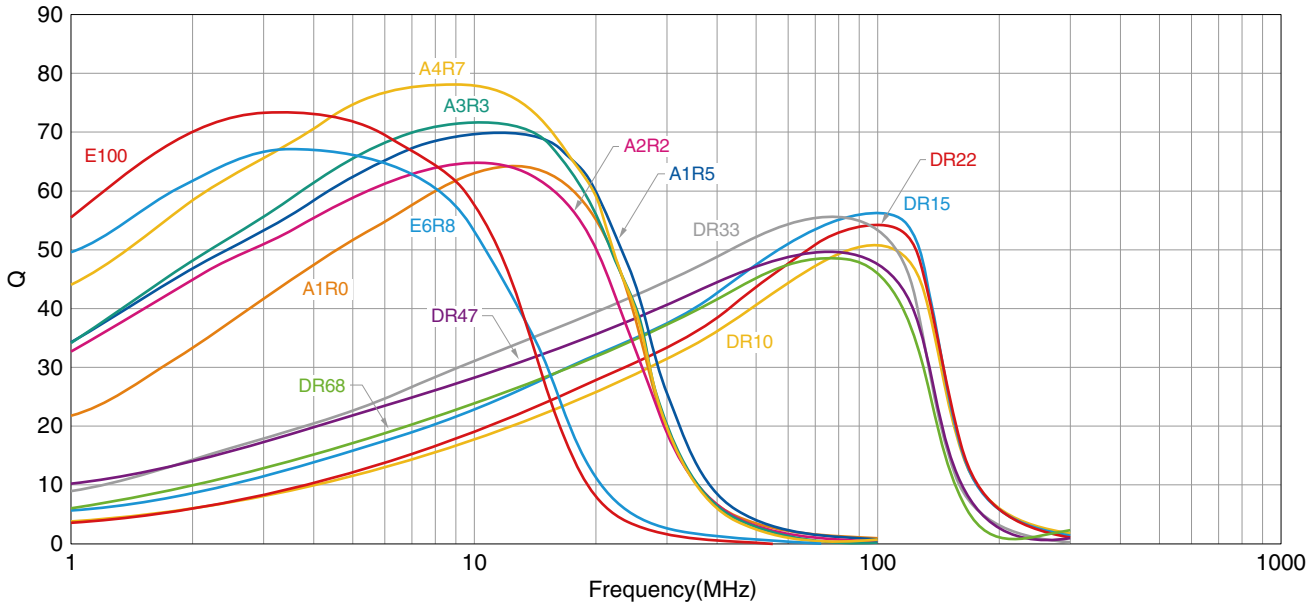
Product No.	Manufacturer
4294A+16034G	Keysight Technologies

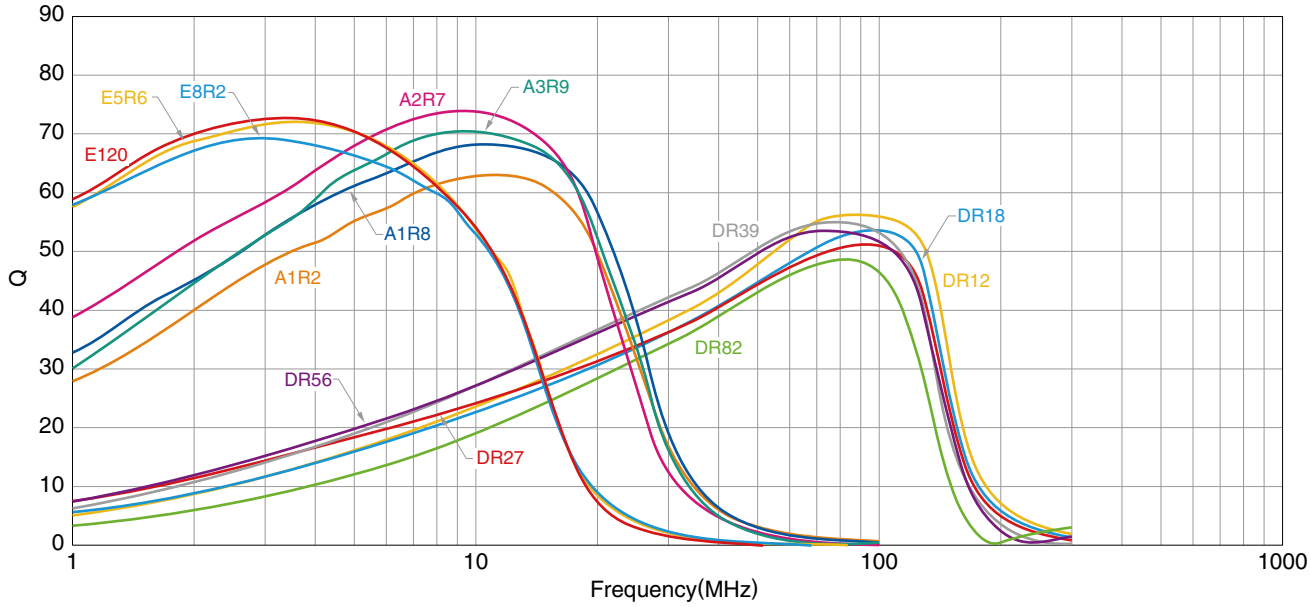
＊ Equivalent measurement equipment may be used.

MLF2012 Type

■ELECTRICAL CHARACTERISTICS

□Q FREQUENCY CHARACTERISTICS GRAPH





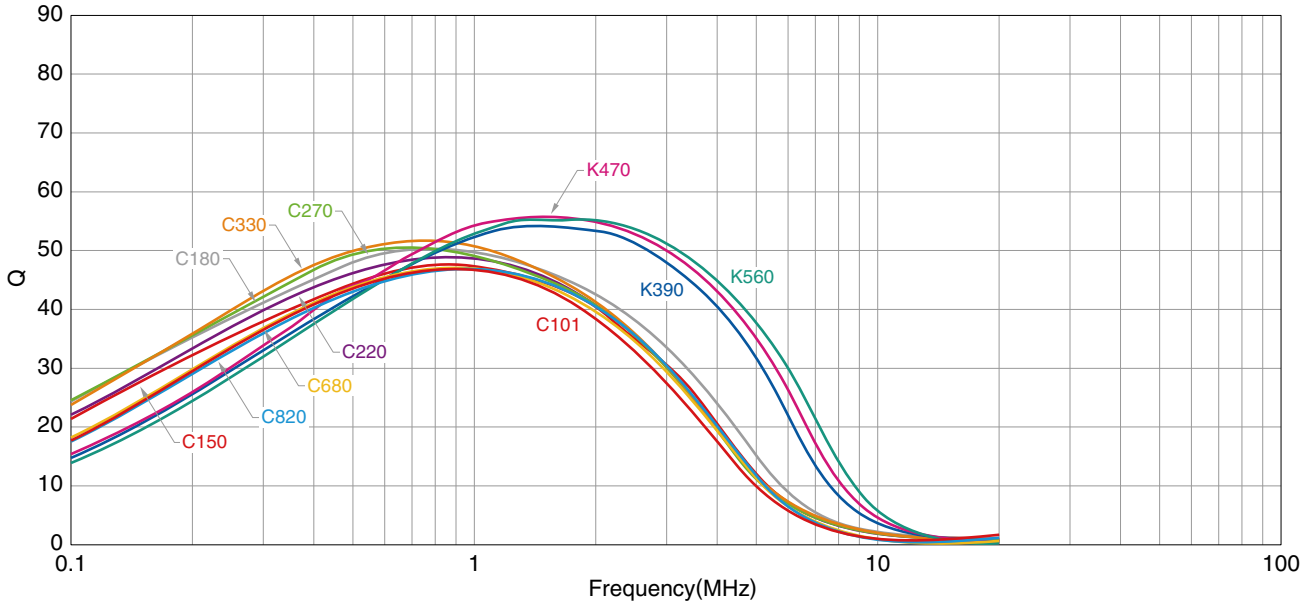
○ Measurement equipment

Product No.	Manufacturer
E4991A+16192A	Keysight Technologies

＊ Equivalent measurement equipment may be used.

MLF2012 Type

□Q FREQUENCY CHARACTERISTICS GRAPH



○ Measurement equipment

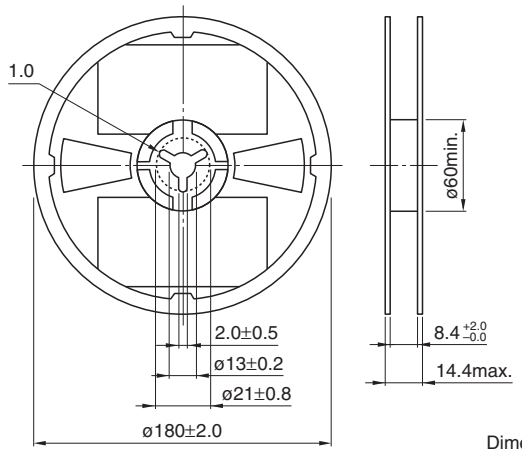
Product No.	Manufacturer
4294A+16034G	Keysight Technologies

∗ Equivalent measurement equipment may be used.

MLF2012 Type

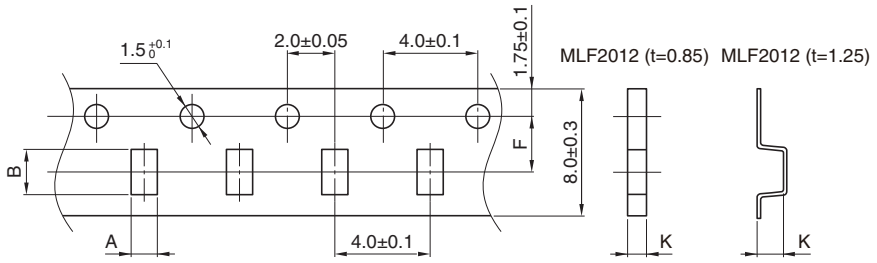
■PACKAGING STYLE

□REEL DIMENSIONS



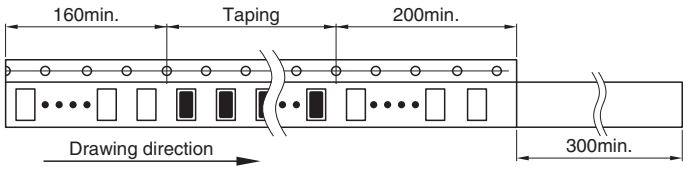
Dimensions in mm

□TAPE DIMENSIONS



Dimensions in mm

Type		A	B	K
MLF2012	t=0.85	1.5±0.2	2.3±0.2	1.1 max.
	t=1.25	1.5±0.2	2.3±0.2	1.5 max.



Dimensions in mm